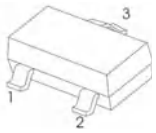
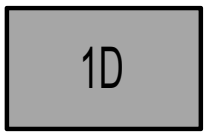
FEATURES

- High breakdown voltage
- Low collector-emitter saturation voltag
- Complementary to MMBTA92 (NPN)

SOT-23





1.BASE
2.EMITTER
3.COLLECTOR

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

MAXIMUM RATINGS (Ta=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Collector–Base Voltage	V_{CBO}	300	V
Collector–Emitter Voltage	V_{CEO}	300	V
Emitter–Base Voltage	V_{EBO}	5	V
Collector Current — Continuous	I_C	0.3	A
Collector Current-Peak	I_{CM}	0.5	A
Collector Power Dissipation	P_C	0.35	W
Thermal Resistance, junction to Ambient	R_{thJA}	357	℃/W
Junction Temperature	T_J	150	℃
Storage Temperature	T_{stg}	-55~+150	℃

ELECTRICAL CHARACTERISTICS (TA = 25°C unless otherwise noted.)

Parameter	Symbol	Test conditions	Min	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	I_C = 100uA, I_E = 0	300		V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	I_C = 1mA, I_B = 0	300		V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	I_E = 100uA, I_C = 0	5		V
Collector cut-off current	I_{CBO}	V_{CB} = 200V, I_E = 0		0.25	uA
Emitter cut-off current	I_{EBO}	V_{EB} = 5V, I_C =0		0.1	uA
DC current gain	$h_{FE(1)}$	V_{CE} = 10V, I_C = 1mA	60		
	$h_{FE(2)}$	V_{CE} = 10V, I_C = 10mA	100	200	
	$h_{FE(3)}$	V_{CE} = 10V, I_C = 30mA	60		
Collector-emitter saturation voltage	$V_{CE(sat)}$	I_C = 20mA, I_B = 2mA		0.2	V
Base-emitter saturation voltage	$V_{BE(sat)}$	I_C = 20mA, I_B = 2mA		0.9	V
Transition frequency	f_T	V_{CE} = 20V, I_C = 10mA, f=30MHz	50		MHz

RATING AND CHARACTERISTIC CURVES

Fig.1 Static characteristics

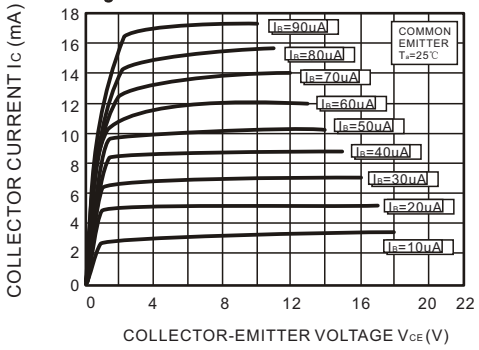


Fig.2 Pc —— Ta

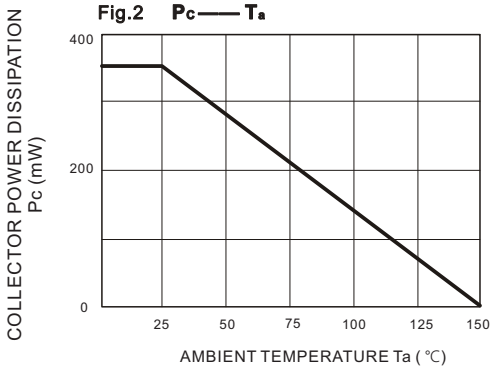


Fig.3 Cob / Cib —— VCB / VEB

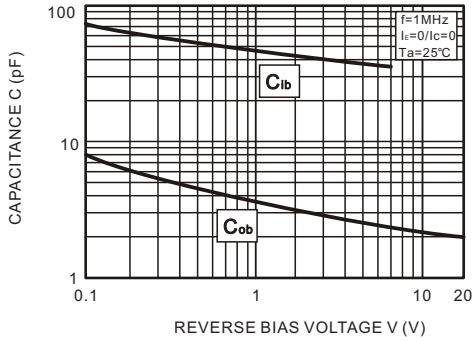


Fig.4 VCEsat —— Ic

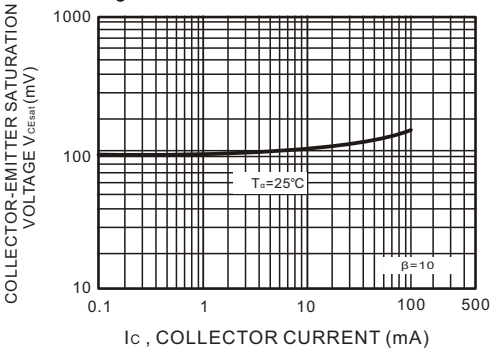


Fig.5 hFE--Ic

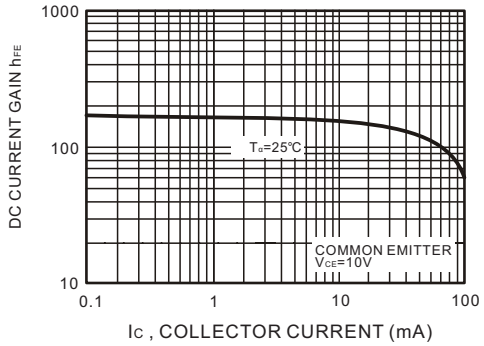


Fig.6 VBEsat —— Ic

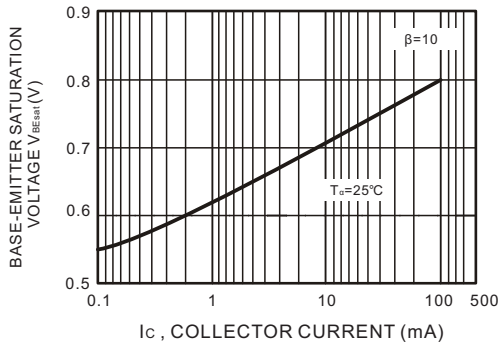


Fig.7 Ic —— VBE

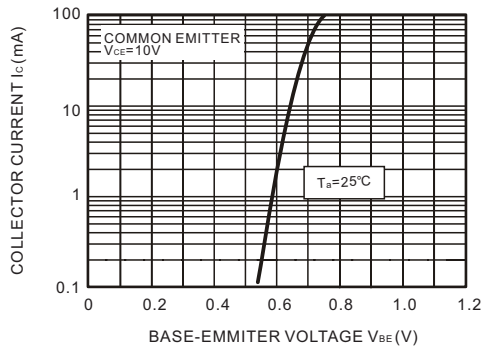
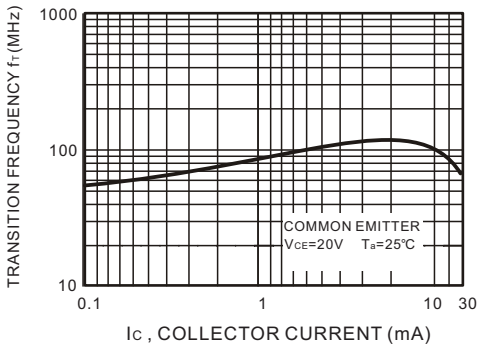


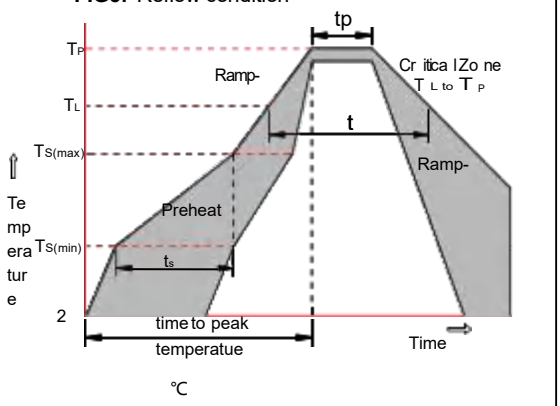
Fig.8 fT —— Ic



Soldering parameters

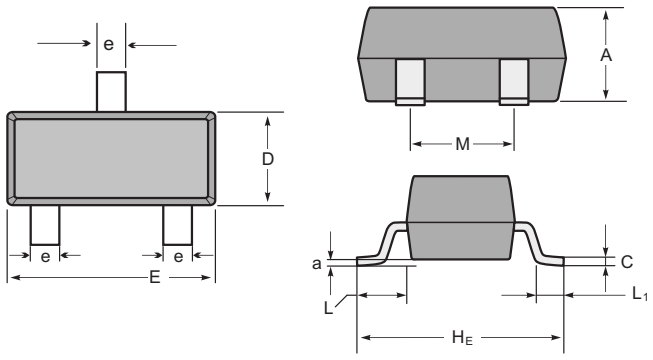
Reflow Condition		Pb-Free assembly (see as bellow)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150℃
	-Temperature Max($T_{s(max)}$)	+200℃
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3℃/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3℃/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217℃
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)℃
Time within 5℃ of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6℃/sec. Max
Time 25℃ to Peak Temp (T_P)		8 min. Max
Do not exceed		+260℃

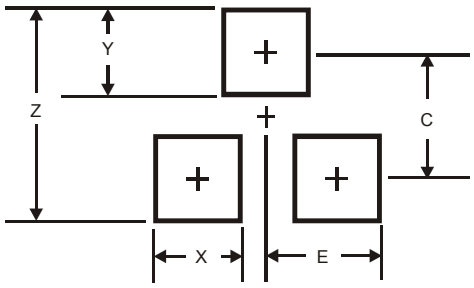
FIG5: Reflow condition



Package Dimensions & Suggested Pad Layout

SOT23





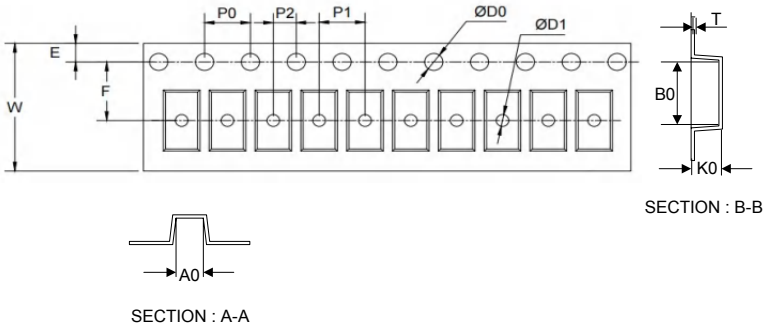
SOT-23 mechanical data

UNIT		A	C	D	E	H_E	e	M	L	L_1	a
mm	max	1.1	0.15	1.4	3.0	2.6	0.5	1.95	0.55 (ref)	0.36 (ref)	0.0
	min	0.9	0.08	1.2	2.8	2.2	0.3	1.7			0.15
mil	max	43	6	55	118	102	20	77	22 (ref)	14 (ref)	0.0
	min	35	3	47	110	87	12	67			6

Dimensions	SOT23
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

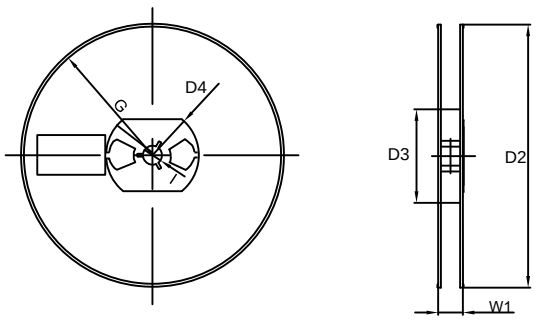
Tape & rell specification

Tape



Symbol	Dimension (mm)
P0	4.00±0.10
P1	4.00±0.10
P2	2.00±0.10
D0	1.55±0.10
D1	1.05±0.10
E	1.55±0.10
F	3.60±0.10
W	8.00±0.10
A0	3.80±0.20
B0	3.25±0.20
K0	1.45±0.10
T	0.25±0.05

7” Reel



D2	178.0±3.0
D3	55Min.
D4	R24.0±3.0
G	R82.0±3.0
I	13.0±2.0
W1	11.0±3.0
Quantity: 3000PCS	